

2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Rev. 06 — 15 June 2009

**Product data sheet** 

# 1. General description

The PCA9543A/43B/43C is a bidirectional translating switch, controlled by the I<sup>2</sup>C-bus. The SCL/SDA upstream pair fans out to two downstream pairs, or channels. Any individual SCx/SDx channels or combination of channels can be selected, determined by the contents of the programmable control register. Two interrupt inputs, INTO and INT1, one for each of the downstream pairs, are provided. One interrupt output, INT, which acts as an AND of the two interrupt inputs, is provided.

An active LOW reset input allows the PCA9543X to recover from a situation where one of the downstream  $I^2C$ -buses is stuck in a LOW state. Pulling the RESET pin LOW resets the  $I^2C$ -bus state machine and causes all the channels to be deselected, as does the internal power-on reset function.

The pass gates of the switches are constructed such that the V<sub>DD</sub> pin can be used to limit the maximum high voltage which will be passed by the PCA9543X. This allows the use of different bus voltages on each SCx/SDx pair, so that 1.8 V, 2.5 V, or 3.3 V parts can communicate with 5 V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5 V tolerant.

The PCA9543A, PCA9543B and PCA9543C are identical except for the fixed portion of the slave address.

## 2. Features

- 1-of-2 bidirectional translating switches
- I<sup>2</sup>C-bus interface logic; compatible with SMBus standards
- 2 active LOW interrupt inputs
- Active LOW interrupt output
- Active LOW reset input
- 2 address pins allowing up to 4 devices on the I<sup>2</sup>C-bus
- Alternate address versions A, B and C allow up to a total of 12 devices on the bus for larger systems or to resolve address conflicts
- Channel selection via I<sup>2</sup>C-bus, in any combination
- Power-up with all switch channels deselected
- Low R<sub>on</sub> switches
- Allows voltage level translation between 1.8 V, 2.5 V, 3.3 V and 5 V buses
- No glitch on power-up
- Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V



- 5 V tolerant inputs
- 0 Hz to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115, and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: SO14, TSSOP14

# 3. Ordering information

#### Table 1.Ordering information

Type number	Package						
	Name	Description	Version				
PCA9543AD	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1				
PCA9543APW	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1				
PCA9543BPW		body width 4.4 mm					
PCA9543CPW							

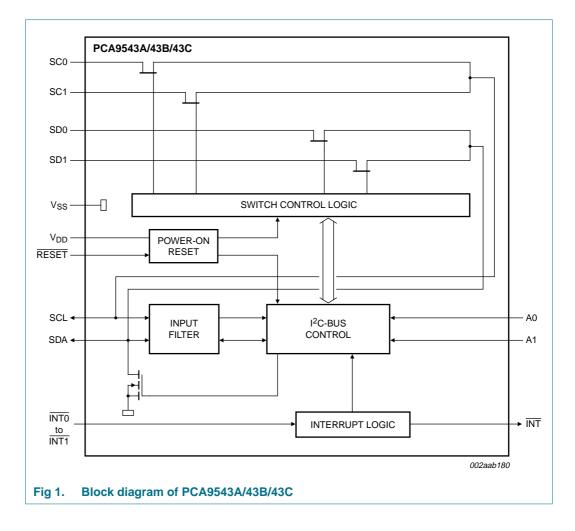
## 3.1 Ordering options

### Table 2. Ordering options

Type number	Topside mark	Temperature range (T <sub>amb</sub> )
PCA9543AD	PCA9543AD	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$
PCA9543APW	PA9543A	$T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$
PCA9543BPW	PA9543B	$T_{amb} = -40 \ ^{\circ}C \text{ to } +85 \ ^{\circ}C$
PCA9543CPW	PA9543C	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$

## 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 4. Block diagram

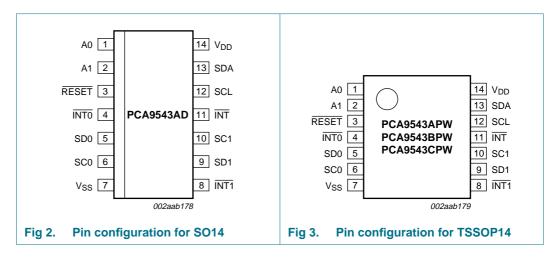


PCA9543A\_43B\_43C\_6

2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 5. Pinning information

# 5.1 Pinning



## 5.2 Pin description

## Table 3. Pin description

Table 3.	Pin description	
Symbol	Pin	Description
A0	1	address input 0
A1	2	address input 1
RESET	3	active LOW reset input
INT0	4	active LOW interrupt input 0
SD0	5	serial data 0
SC0	6	serial clock 0
$V_{SS}$	7	supply ground
INT1	8	active LOW interrupt input 1
SD1	9	serial data 1
SC1	10	serial clock 1
INT	11	active LOW interrupt output
SCL	12	serial clock line
SDA	13	serial data line
V <sub>DD</sub>	14	supply voltage

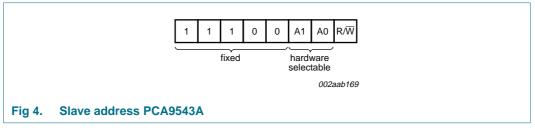
#### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 6. Functional description

Refer to Figure 1 "Block diagram of PCA9543A/43B/43C".

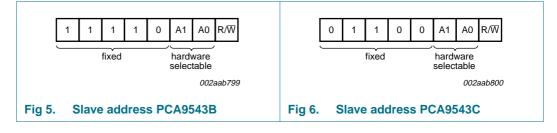
### 6.1 Device address

Following a START condition, the bus master must output the address of the slave it is accessing. The address of the PCA9543A is shown in <u>Figure 4</u>. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.



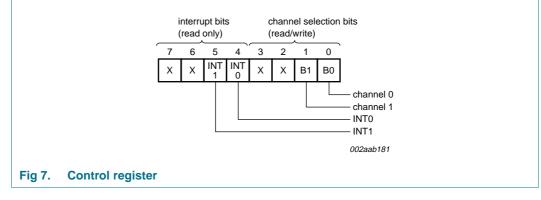
The last bit of the slave address defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

The PCA9543B and PCA9543C are alternate address versions if needed for larger systems or to resolve address conflicts. The data sheet will reference the PCA9543A, but the PCA9543B and PCA9543C function identically except for the slave address.



### 6.2 Control register

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9543A, which will be stored in the control register. If multiple bytes are received by the PCA9543A, it will save the last byte received. This register can be written and read via the I<sup>2</sup>C-bus.



5 of 23

#### 6.2.1 Control register definition

One or several SCx/SDx downstream pair, or channel, is selected by the contents of the control register. This register is written after the PCA9543A has been addressed. The 2 LSBs of the control byte are used to determine which channel is to be selected. When a channel is selected, the channel will become active after a STOP condition has been placed on the I<sup>2</sup>C-bus. This ensures that all SCx/SDx lines will be in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection.

			,				,	
D7	D6	INT1	INT0	D3	D2	B1	B0	Command
х	х	Х	х	х	v	х	0	channel 0 disabled
~	^	~	~	~	~	~	1	channel 0 enabled
х	v	Х	Х	Х	Y	0	×	channel 1 disabled
^	^	~	~	~	~	1	~	channel 1 enabled
0	0	0	0	0	0	0	0	no channel selected; power-up/reset default state

Table 4. Control register: Write-channel selection: Read-channel status

**Remark:** Channel 0 and channel 1 can be enabled at the same time. Care should be taken not to exceed the maximum bus capacitance.

#### 6.2.2 Interrupt handling

The PCA9543A provides 2 interrupt inputs, one for each channel, and one open-drain interrupt output. When an interrupt is generated by any device, it will be detected by the PCA9543A and the interrupt output will be driven LOW. The channel need not be active for detection of the interrupt. A bit is also set in the control register.

Bit 4 and bit 5 of the control register corresponds to the INTO and INT1 inputs of the PCA9543A, respectively. Therefore, if an interrupt is generated by any device connected to channel 1, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 would cause bit 4 of the control register to be set on the read. The master can then address the PCA9543A and read the contents of the control register to determine which channel contains the device generating the interrupt. The master can then reconfigure the PCA9543A to select this channel, and locate the device generating the interrupt and clear it.

It should be noted that more than one device can provide an interrupt on a channel, so it is up to the master to ensure that all devices on a channel are interrogated for an interrupt.

The interrupt inputs may be used as general purpose inputs if the interrupt function is not required.

If unused, interrupt input(s) must be connected to V<sub>DD</sub> through a pull-up resistor.

Table	5.	Control reg	gister: Ro	ead—i	nterrupt			
7	6	INT1	INT0	3	2	B1	B0	Command
Y	Y	Y	0	Y	×	Y	Y	no interrupt on channel 0
^	^	$X   X   \frac{0}{1}   X   X   X   X$		Λ	interrupt on channel 0			
Y	Y	0	X	Y	Х	Y	Y	no interrupt on channel 1
^	~	1	~	Λ	~	Λ	Λ	interrupt on channel 1

## . . . .

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**Remark:** Two interrupts can be active at the same time.

## 6.3 **RESET** input

The RESET input is an active LOW signal which may be used to recover from a bus fault condition. By asserting this signal LOW for a minimum of  $t_{w(rst)L}$ , the PCA9543A will reset its registers and I<sup>2</sup>C-bus state machine and will deselect all channels. The RESET input must be connected to V<sub>DD</sub> through a pull-up resistor.

### 6.4 Power-on reset

When power is applied to  $V_{DD}$ , an internal Power-On Reset (POR) holds the PCA9543A in a reset condition until  $V_{DD}$  has reached  $V_{POR}$ . At this point, the reset condition is released and the PCA9543A registers and I<sup>2</sup>C-bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter,  $V_{DD}$  must be lowered below 0.2 V to reset the device.

## 6.5 Voltage translation

The pass gate transistors of the PCA9543A are constructed such that the  $V_{DD}$  voltage can be used to limit the maximum voltage that will be passed from one I<sup>2</sup>C-bus to another.

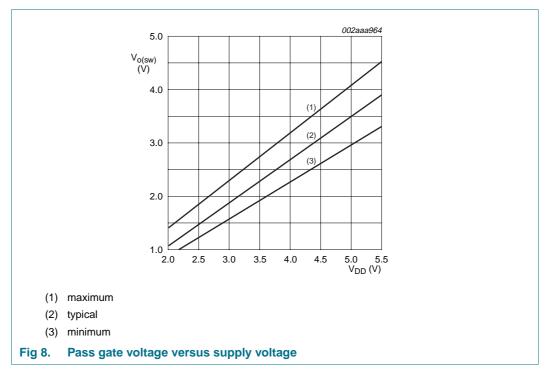


Figure 8 shows the voltage characteristics of the pass gate transistors (note that the graph was generated using the data specified in Section 10 "Static characteristics" of this data sheet). In order for the PCA9543A to act as a voltage translator, the  $V_{o(sw)}$  voltage should be equal to, or lower than the lowest bus voltage. For example, if the main bus was running at 5 V, and the downstream buses were 3.3 V and 2.7 V, then  $V_{o(sw)}$  should be equal to or below 2.7 V to effectively clamp the downstream bus voltages. Looking at

#### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Figure 8, we see that  $V_{o(sw)(max)}$  will be at 2.7 V when the PCA9543A supply voltage is 3.5 V or lower, so the PCA9543A supply voltage could be set to 3.3 V. Pull-up resistors can then be used to bring the bus voltages to their appropriate levels (see Figure 15).

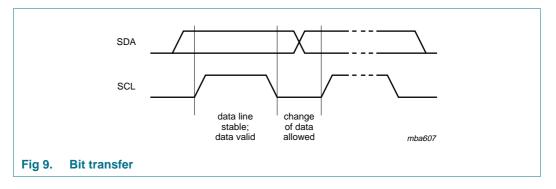
More Information can be found in Application Note AN262: PCA954X family of I<sup>2</sup>C/SMBus multiplexers and switches.

# 7. Characteristics of the l<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

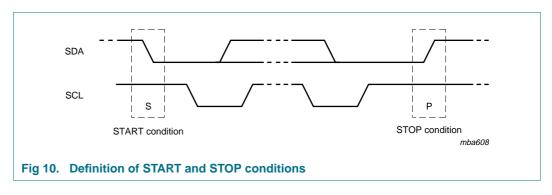
## 7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 9).



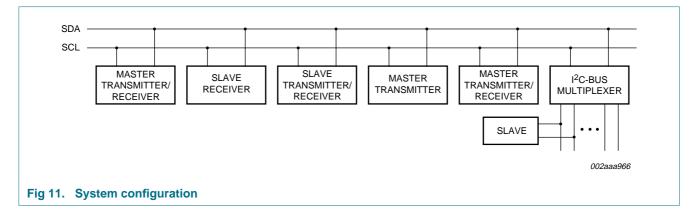
## 7.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see Figure 10).



## 7.3 System configuration

A device generating a message is a 'transmitter', a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see Figure 11).

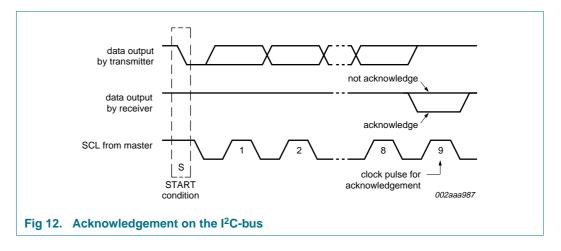


## 7.4 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also, a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

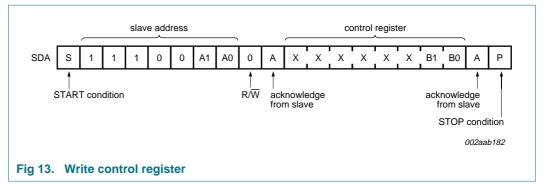
A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.



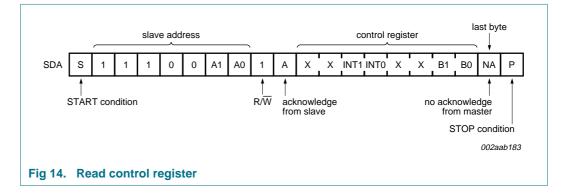
### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

### 7.5 Bus transactions

Data is transmitted to the PCA9543A control register using the Write mode as shown in Figure 13.

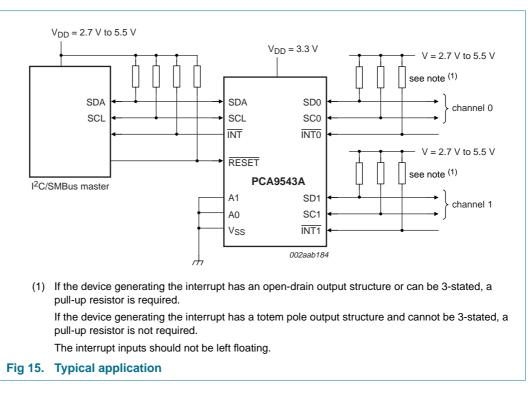


Data is read from PCA9543A using the Read mode as shown in Figure 14.



#### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 8. Application design-in information



# 9. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS}$  (ground = 0 V).[1]

00 10	,				
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I	input current		-	±20	mA
lo	output current		-	±25	mA
I <sub>DD</sub>	supply current		-	±100	mA
I <sub>SS</sub>	ground supply current		-	±100	mA
P <sub>tot</sub>	total power dissipation		-	400	mW
T <sub>stg</sub>	storage temperature		-60	+150	°C
T <sub>amb</sub>	ambient temperature	operating	-40	+85	°C

[1] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 125 °C.

2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# **10. Static characteristics**

#### Table 7.Static characteristics at $V_{DD} = 2.3$ V to 3.6 V

 $V_{SS} = 0 V$ ;  $T_{amb} = -40 \degree C$  to +85 °C; unless otherwise specified. See <u>Table 8 on page 13</u> for  $V_{DD} = 4.5 V$  to 5.5 V.[1]

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						
V <sub>DD</sub>	supply voltage		2.3	-	3.6	V
I <sub>DD</sub>	supply current	operating mode; $V_{DD}$ = 3.6 V; no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub> ; f <sub>SCL</sub> = 100 kHz	-	40	100	μA
I <sub>stb</sub>	standby current	Standby mode; $V_{DD}$ = 3.6 V; no load; $V_I = V_{DD}$ or $V_{SS}$ ; $f_{SCL}$ = 0 kHz	-	0.2	1	μA
V <sub>POR</sub>	power-on reset voltage	no load; $V_I = V_{DD}$ or $V_{SS}$	[2]	1.6	2.1	V
Input SCI	.; input/output SDA					
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
VIH	HIGH-level input voltage		$0.7 V_{DD}$	-	6	V
I <sub>OL</sub>	LOW-level output current	$V_{OL} = 0.4 V$	3	-	-	mA
		V <sub>OL</sub> = 0.6 V	6	-	-	mA
IL	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μΑ
Ci	input capacitance	$V_{I} = V_{SS}$	-	9	10	pF
Select inp	outs A0, A1, INTO, INT1, RE	SET				
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7 V_{DD}$	-	V <sub>DD</sub> + 0.5	V
I <sub>LI</sub>	input leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	–1	-	+1	μA
Ci	input capacitance	$V_{I} = V_{SS}$	-	1.6	3	pF
Pass gate	)					
R <sub>on</sub>	ON-state resistance	$V_{DD}$ = 3.0 to 3.6 V; $V_O$ = 0.4 V; $I_O$ = 15 mA	5	11	30	Ω
		$V_{DD}$ = 2.3 V to 2.7 V; $V_{O}$ = 0.4 V; $I_{O}$ = 10 mA	7	16	55	Ω
V <sub>o(sw)</sub>	switch output voltage	$V_{i(sw)}$ = $V_{DD}$ = 3.3 V; $I_{o(sw)}$ = $-100~\mu\text{A}$	-	1.9	-	V
		$V_{i(sw)} = V_{DD} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{o(sw)} = -100 \mu\text{A}$	1.6	-	2.8	V
		$V_{i(sw)} = V_{DD} = 2.5 \text{ V}; I_{o(sw)} = -100 \mu\text{A}$	-	1.5	-	V
		$V_{i(sw)} = V_{DD} = 2.5 \text{ V to } 2.7 \text{ V};$ $I_{o(sw)} = -100  \mu\text{A}$	1.1	-	2.0	V
IL	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μA
C <sub>io</sub>	input/output capacitance	$V_{I} = V_{SS}$	-	3	5	pF
INT outpu	ıt					
I <sub>OL</sub>	LOW-level output current	$V_{OL} = 0.4 V$	3	-	-	mA
I <sub>OH</sub>	HIGH-level output current		-	-	+100	μA

[1] For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

[2]  $V_{DD}$  must be lowered to 0.2 V in order to reset part.

### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Symbol	Parameter	Conditions	N	lin	Тур	Max	Unit
Supply							
V <sub>DD</sub>	supply voltage		4	.5	-	5.5	V
I <sub>DD</sub>	supply current	Operating mode; $V_{DD} = 5.5 \text{ V}$ ; no load; $V_I = V_{DD}$ or $V_{SS}$ ; $f_{SCL} = 100 \text{ kHz}$	-		25	100	μΑ
l <sub>stb</sub>	standby current	Standby mode; $V_{DD} = 5.5 V$ ; no load; $V_I = V_{DD}$ or $V_{SS}$ ; $f_{SCL} = 0 \text{ kHz}$	-		0.2	1	μA
V <sub>POR</sub>	power-on reset voltage	no load; $V_I = V_{DD}$ or $V_{SS}$	[2] _		1.7	2.1	V
Input SCL	; input/output SDA						
VIL	LOW-level input voltage		_	0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		0	.7V <sub>DD</sub>	-	6	V
l <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3		-	-	mA
		V <sub>OL</sub> = 0.6 V	6	i	-	-	mA
L	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	_	·1	-	+1	μA
Ci	input capacitance	$V_I = V_{SS}$	-		9	10	pF
Select inp	outs A0, A1, INTO to INT3, R	ESET					
VIL	LOW-level input voltage		_	0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		0	.7V <sub>DD</sub>	-	V <sub>DD</sub> + 0.5	V
I <sub>LI</sub>	input leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	_	·1	-	+50	μA
C <sub>i</sub>	input capacitance	$V_I = V_{SS}$	-		2	5	pF
Pass gate	1						
R <sub>on</sub>	on-state resistance	$V_{DD}$ = 4.5 V to 5.5 V; $V_{O}$ = 0.4 V; $I_{O}$ = 15 mA	4		9	24	Ω
V <sub>o(sw)</sub>	switch output voltage	$\label{eq:Visw} \begin{split} V_{i(sw)} &= V_{DD} = 5.0 \ V; \\ I_{o(sw)} &= -100 \ \mu A \end{split}$	-		3.6	-	V
		$\label{eq:Visw} \begin{array}{l} V_{i(sw)} = V_{DD} = 4.5 \ V \ to \ 5.5 \ V; \\ I_{o(sw)} = -100 \ \mu A \end{array}$	2	6	-	4.5	V
L	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	_	1	-	+100	μA
C <sub>io</sub>	input/output capacitance	$V_{I} = V_{SS}$	-		3	5	pF
NT outpu	t						
I <sub>OL</sub>	LOW-level output current	$V_{OL} = 0.4 V$	3		-	-	mA
I <sub>OH</sub>	HIGH-level output current		-		-	+100	μΑ

#### Table 8. Static characteristics at $V_{DD}$ = 4.5 V to 5.5 V

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[1] For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

[2]  $V_{DD}$  must be lowered to 0.2 V in order to reset part.

#### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# **11. Dynamic characteristics**

Symbol	Parameter	Conditions		Standard-mode I <sup>2</sup> C-bus		Fast-mode I <sup>2</sup>	C-bus	Unit
				Min	Max	Min	Max	
t <sub>PD</sub>	propagation delay	from SDA to SDx, or SCL to SCx		-	0.3 <mark>[1]</mark>	-	0.3 <mark>[1]</mark>	ns
f <sub>SCL</sub>	SCL clock frequency			0	100	0	400	kHz
t <sub>BUF</sub>	bus free time between a STOP and START condition			4.7	-	1.3	-	μs
t <sub>HD;STA</sub>	hold time (repeated) START condition		[2]	4.0	-	0.6	-	μs
t <sub>LOW</sub>	LOW period of the SCL clock			4.7	-	1.3	-	μs
t <sub>HIGH</sub>	HIGH period of the SCL clock			4.0	-	0.6	-	μs
t <sub>SU;STA</sub>	set-up time for a repeated START condition			4.7	-	0.6	-	μs
t <sub>SU;STO</sub>	set-up time for STOP condition			4.0	-	0.6	-	μs
t <sub>HD;DAT</sub>	data hold time			0 <mark>[3]</mark>	3.45	0 <mark>[3]</mark>	0.9	μs
t <sub>SU;DAT</sub>	data set-up time			250	-	100	-	ns
t <sub>r</sub>	rise time of both SDA and SCL signals			-	1000	20 + 0.1C <sub>b</sub> <sup>[4]</sup>	300	ns
t <sub>f</sub>	fall time of both SDA and SCL signals			-	300	20 + 0.1C <sub>b</sub> <sup>[4]</sup>	300	ns
C <sub>b</sub>	capacitive load for each bus line			-	400	-	400	pF
t <sub>SP</sub>	pulse width of spikes that must be suppressed by the input filter			-	50	-	50	ns
t <sub>VD;DAT</sub>	data valid time	HIGH-to-LOW	[5]	-	1	-	1	μs
		LOW-to-HIGH	[5]	-	0.6	-	0.6	μs
t <sub>VD;ACK</sub>	data valid acknowledge time			-	1	-	1	μs
INT								
t <sub>v(INTnN-INTN</sub>	$_{\rm II}$ valid time from $\overline{\rm INTn}$ to $\overline{\rm INT}$ signal			-	4	-	4	μs
t <sub>d(INTnN-INTN</sub>	$v_{0}$ delay time from $\overline{INTn}$ to $\overline{INT}$ inactive			-	2	-	2	μs
t <sub>w(rej)L</sub>	LOW-level rejection time	INTn inputs		1	-	1	-	μs
t <sub>w(rej)H</sub>	HIGH-level rejection time	INTn inputs		0.5	-	0.5	-	μs
RESET								
t <sub>w(rst)L</sub>	LOW-level reset time			4	-	4	-	ns
t <sub>rst</sub>	reset time	SDA clear		500	-	500	-	ns
t <sub>REC;STA</sub>	recovery time to START condition			0	-	0	-	ns

[1] Pass gate propagation delay is calculated from the 20  $\Omega$  typical R<sub>on</sub> and the 15 pF load capacitance.

[2] Hold time (repeated) START condition. After this period, the first clock pulse is generated.

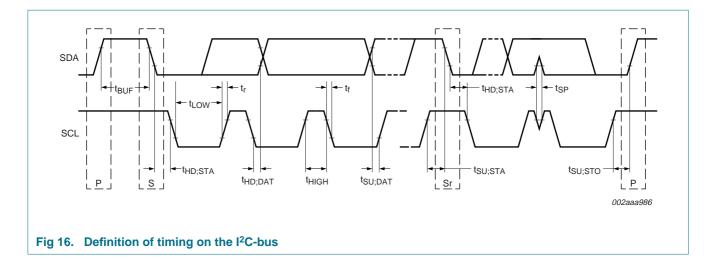
[3] A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V<sub>IH(min)</sub> of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

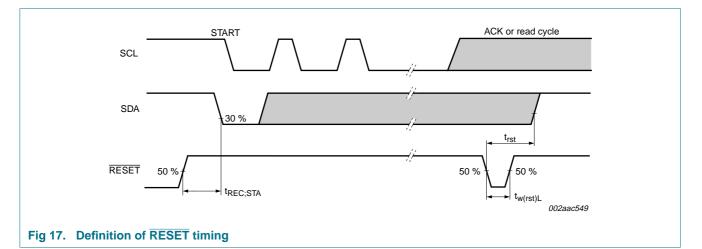
[4]  $C_b$  = total capacitance of one bus line in pF.

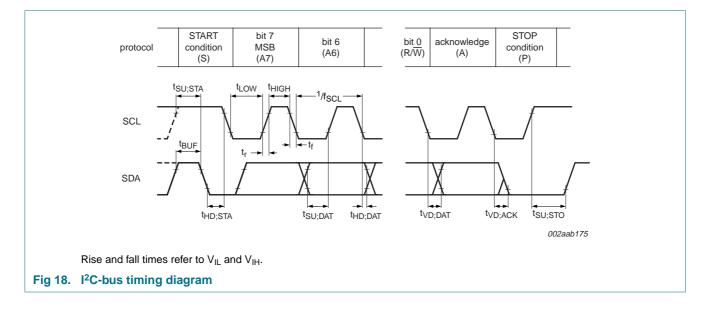
[5] Measurements taken with 1 k $\Omega$  pull-up resistor and 50 pF load.

PCA9543A\_43B\_43C\_6 Product data sheet

## 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset







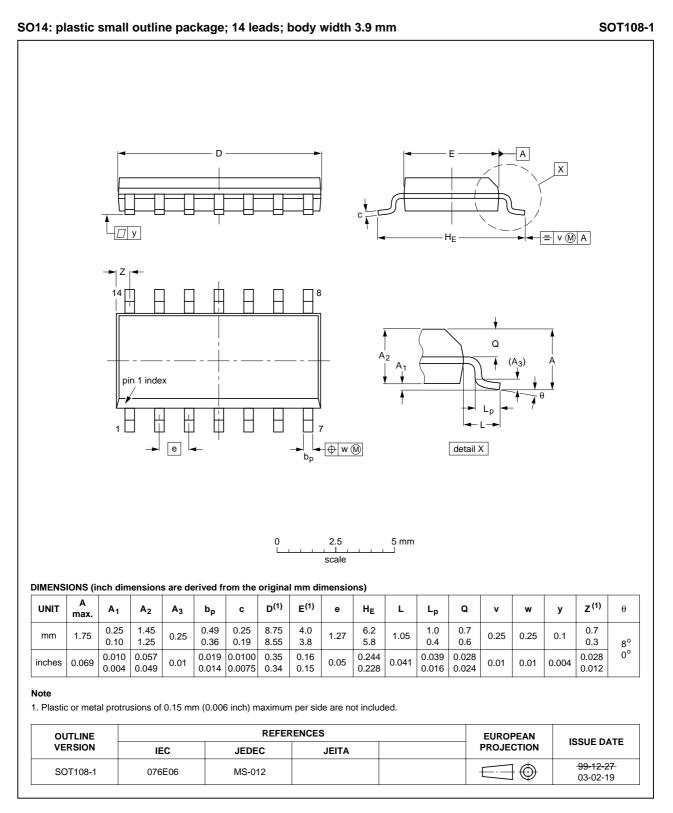
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### **NXP Semiconductors**

# PCA9543A/43B/43C

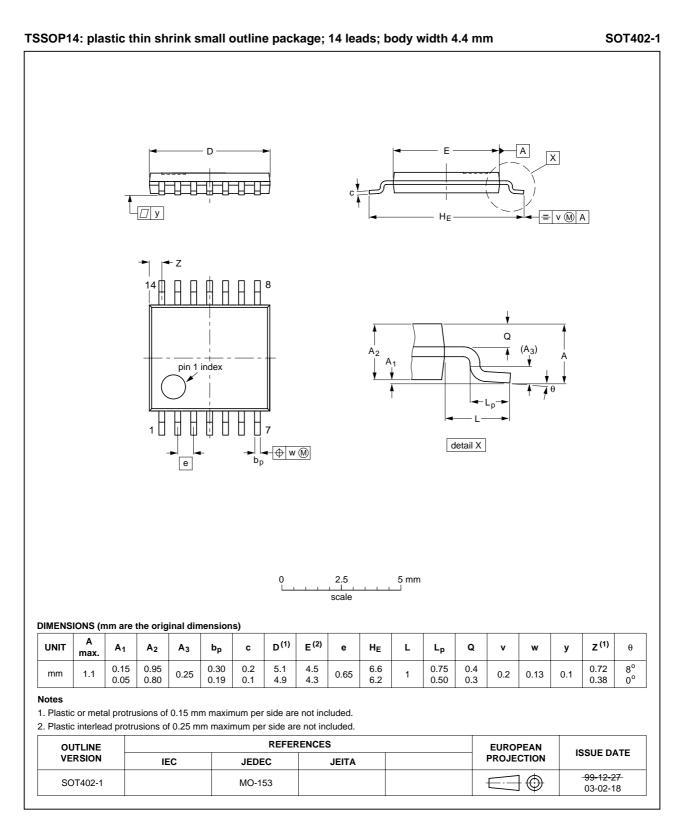
#### 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 12. Package outline



#### Fig 19. Package outline SOT108-1 (SO14)

2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



#### Fig 20. Package outline SOT402-1 (TSSOP14)

PCA9543A\_43B\_43C\_6

# **13. Soldering of SMD packages**

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

## 13.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

## 13.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 13.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

## 13.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 21</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 10 and 11

#### Table 10. SnPb eutectic process (from J-STD-020C)

Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm <sup>3</sup> )				
	< 350	≥ 350			
< 2.5	235	220			
≥ 2.5	220	220			

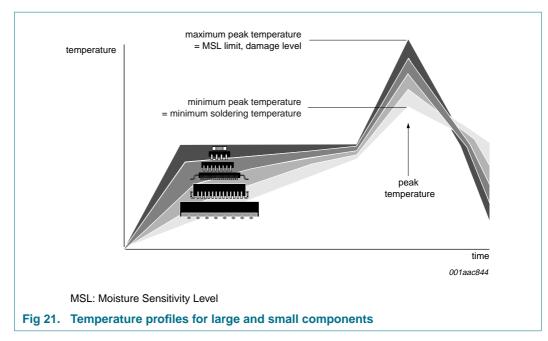
#### Table 11. Lead-free process (from J-STD-020C)

Package thickness (mm) Package reflow temperature (°C)						
	Volume (mm <sup>3</sup> )					
	< 350	350 to 2000	> 2000			
< 1.6	260	260	260			
1.6 to 2.5	260	250	245			
> 2.5	250	245	245			

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 21.

## 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



For further information on temperature profiles, refer to Application Note AN10365 "Surface mount reflow soldering description".

# 14. Abbreviations

Table 12.	Abbreviations
Acronym	Description
CDM	Charged-Device Model
ESD	ElectroStatic Discharge
HBM	Human Body Model
IC	Integrated Circuit
I <sup>2</sup> C-bus	Inter-Integrated Circuit bus
LSB	Least Significant Bit
MM	Machine Model
MSB	Most Significant Bit
PCB	Printed-Circuit Board
SMBus	System Management Bus

PCA9543A\_43B\_43C\_6

## 2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 15. Revision history

Table 13. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA9543A_43B_43C_6	20090615	Product data sheet	-	PCA9543A_43B_43C_5
Modifications:	<ul> <li>Table 9 "Dyna</li> </ul>	amic characteristics":		
	<ul> <li>Symbol t<sub>f</sub>:</li> </ul>	changed Unit from "µs" to	"ns"	
	<ul> <li>Symbol C</li> </ul>	<sub>b</sub> : changed Unit from "µs" t	to "pF"	
PCA9543A_43B_43C_5	20081117	Product data sheet	-	PCA9543A_43B_43C_4
PCA9543A_43B_43C_4	20061020	Product data sheet	-	PCA9543A_3
PCA9543A_3 (9397 750 14316)	20050321	Product data sheet	-	PCA9543A_2
PCA9543A_2 (9397 750 13988)	20040929	Objective data sheet	-	PCA9543A_1
PCA9543A_1 (9397 750 13299)	20040728	Objective data sheet	-	-

# **16. Legal information**

## 16.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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# PCA9543A/43B/43C

2-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## **18. Contents**

1	General description	. 1
2	Features	. 1
3	Ordering information	. 2
3.1	Ordering options	. 2
4	Block diagram	. 3
5	Pinning information	
5.1	Pinning	
5.2	Pin description	
6	Functional description	. 5
6.1	Device address	. 5
6.2	Control register	. 5
6.2.1	Control register definition	. 6
6.2.2	Interrupt handling	. 6
6.3	RESET input	
6.4	Power-on reset	
6.5	Voltage translation	
7	Characteristics of the I <sup>2</sup> C-bus	. 8
7.1	Bit transfer	
7.2	START and STOP conditions	
7.3	System configuration	
7.4	Acknowledge	
7.5	Bus transactions	
8	Application design-in information	11
9	Limiting values	11
10	Static characteristics	12
11	Dynamic characteristics	14
12	Package outline	16
13	Soldering of SMD packages	18
13.1	Introduction to soldering	18
13.2	Wave and reflow soldering	18
13.3	Wave soldering	18
13.4	Reflow soldering	19
14	Abbreviations	20
15	Revision history	21
16	Legal information	22
16.1	Data sheet status	22
16.2	Definitions	22
16.3	Disclaimers	22
16.4	Trademarks	22
17	Contact information	22
18	Contents	23

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